

Min track width – 8mils (200 microns)

Min space track/pad – 6mils (200 microns)

Min space track/track – 6mils (250 microns)

Max panel size – 480 x 580 mm

Min thickness of the board – 0,1mm

Max thickness of the board – 3,2mm

Min hole – 0,3mm

Max layers – 8

Max aspect ratio – 4:1

Soldermask – liquid, photosensible

Soldermask colour – dark-green (standard), grass-green, blue, red, black, white

Copper thickness inside hole → 25 microns